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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/901,046	07/10/2001	Akio Uenishi	50090-308	6444
75	90 02/07/2002			
McDermott, Will & Emery 600 13th Street, N.W. Washington,, DC 20005-3096			EXAMINER	
			VU, QUANG D	
			ART UNIT	PAPER NUMBER
			2811	
			DATE MAILED: 02/07/2002	

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)			
Office Action Commence	09/901,046	UENISHI, AKIO			
Office Action Summary	Examiner	Art Unit			
The MAN INO DATE And	Quang D Vu	2811			
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply					
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply If NO period for reply is specified above, the maximum statutory period we Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b). Status	6(a). In no event, however, may within the statutory minimum of ill apply and will expire SIX (6) No cause the application to become	thirty (30) days will be considered timely. NONTHS from the mailing date of this communication. ABANDONED (35 U.S.C. § 133).			
1) Responsive to communication(s) filed on					
	— · s action is non-final.				
3) Since this application is in condition for allowa closed in accordance with the practice under <i>E</i>	nce except for formal r				
Disposition of Claims		·			
4)⊠ Claim(s) <u>1-5</u> is/are pending in the application.					
4a) Of the above claim(s) is/are withdraw	n from consideration.				
5) Claim(s) is/are allowed.					
6)⊠ Claim(s) <u>1-5</u> is/are rejected.					
7) Claim(s) is/are objected to.					
8) Claim(s) are subject to restriction and/or	election requirement.	•			
Application Papers					
9) The specification is objected to by the Examiner	•				
10)☐ The drawing(s) filed on is/are: a)☐ accepted or b)☐ objected to by the Examiner.					
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).					
11) The proposed drawing correction filed on	is: a) ☐ approved b) ☐	disapproved by the Examiner.			
If approved, corrected drawings are required in rep	ly to this Office action.				
12) ☐ The oath or declaration is objected to by the Exa	aminer.				
Priority under 35 U.S.C. §§ 119 and 120					
13)⊠ Acknowledgment is made of a claim for foreign	priority under 35 U.S.0	C. § 119(a)-(d) or (f).			
a)⊠ All b) Some * c) None of:		•			
 Certified copies of the priority documents 	have been received.				
2. Certified copies of the priority documents	have been received in	Application No			
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 					
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).					
 a) The translation of the foreign language provides 15) Acknowledgment is made of a claim for domestic 	- · ·				
Attachment(s)					
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s) 2.	5) Notice	ew Summary (PTO-413) Paper No(s) of Informal Patent Application (PTO-152)			
					

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DETAILED ACTION

Specification

1. Applicant is reminded of the proper content of an abstract of the disclosure.

A patent abstract is a concise statement of the technical disclosure of the patent and should include that which is new in the art to which the invention pertains. If the patent is of a basic nature, the entire technical disclosure may be new in the art, and the abstract should be directed to the entire disclosure. If the patent is in the nature of an improvement in an old apparatus, process, product, or composition, the abstract should include the technical disclosure of the improvement. In certain patents, particularly those for compounds and compositions, wherein the process for making and/or the use thereof are not obvious, the abstract should set forth a process for making and/or use thereof. If the new technical disclosure involves modifications or alternatives, the abstract should mention by way of example the preferred modification or alternative.

The abstract should not refer to purported merits or speculative applications of the invention and should not compare the invention with the prior art.

Where applicable, the abstract should include the following:

- (1) if a machine or apparatus, its organization and operation;
- (2) if an article, its method of making;
- (3) if a chemical compound, its identity and use;
- (4) if a mixture, its ingredients;
- (5) if a process, the steps.

Extensive mechanical and design details of apparatus should not be given.

The abstract of the disclosure is objected to because lines 1 and 2 draw reference to purported merits of the claimed invention. Correction is required. See MPEP § 608.01(b).

Drawings

2. The drawings are objected to under 37 CFR 1.83(a). The drawings must show every feature of the invention specified in the claims. Therefore, the high heat conductor film that is

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united with one of the terminal wirings, as required in claim 5 must be shown or the feature(s) canceled from the claim(s). No new matter should be entered.

A proposed drawing correction or corrected drawings are required in reply to the Office action to avoid abandonment of the application. The objection to the drawings will not be held in abeyance.

Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

4. Claim 1 is rejected under 35 U.S.C. 102(b) as being anticipated by Japanese Patent No. 09232516 to Yasushi et al.

Regarding claim 1, Yasushi et al. teach a semiconductor device, comprising:

- a semiconductor substrate (1);
- a first insulating film (2) formed on the semiconductor substrate;
- a polysilicon resistor film (3) formed on the first insulating film;
- a second insulating film (4) formed on the resistor film;
- a high heat conductor film (8) consisting of a highly heat-conducting material formed on the second insulating film; and

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a pair of terminal wirings (7) formed on the second insulating film and connected to the resistor film,

wherein a thickness of the second insulating film located above the resistor film is thinner than a thickness of the resistor film.

Claim Rejections - 35 USC § 103

- 5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 6. Claims 2 5 are rejected under 35 U.S.C. 103(a) as being unpatentable over Japanese Patent No. 09232516 to Yasushi et al.

Regarding claim 2, Yasushi et al. teach a semiconductor device, comprising:

- a semiconductor substrate;
- a first insulating film formed on the semiconductor substrate;
- a polysilicon resistor film formed on the first insulating film;
- a second insulating film formed on the resistor film;
- a high heat conductor film consisting of a highly heat-conducting material formed on the second insulating film; and
- a pair of terminal wirings formed on the second insulating film and connected to the resistor film.

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Yasushi et al. do not teach a thickness of the second insulating film that is thicker than a thickness of the resistor film. The thickness of insulation layers in semiconductor devices is a known variable. It would have been obvious to one having ordinary skill in the art at the time the invention was made to have a thickness of the second insulating film that is thicker than a thickness of the resistor film as a matter of design choice, since it has been held that discovering an optimum value of a result effective variable involves only routine skill in the art.

Regarding claim 3, Yasushi et al. do not teach a semiconductor device, wherein the thickness of the high heat conductor film is twice the thickness of the resistor film or thicker. It would have been obvious to one having ordinary skill in the art at the time the invention was made to have a thickness of the high heat conductor film is twice the thickness of the resistor film or thicker as a matter of design choice, since it has been held that discovering an optimum value of a result effective variable involves only routine skill in the art. Furthermore, it is obvious that the size of the heat sink will determine the degree of heat transfer from the desired area. It would have been obvious to alter the size of the heat sink according to the desired amount of heat dissipation.

Regarding claim 4, Yasushi et al. teach a semiconductor device, wherein a width of the high heat conductor film is wider than a width of the resistor film.

Regarding claim 5, Yasushi et al. do not teach a semiconductor device, wherein the high heat conductor film is united with one of the terminal wirings. It would have been obvious to connect one of the terminal wirings to the heat sink, since thermal conductivity can be improved.

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Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Quang D Vu whose telephone number is 703-305-3826. The examiner can normally be reached on Monday-Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Tom Thomas can be reached on 703-308-2772. The fax phone numbers for the organization where this application or proceeding is assigned are 703-308-7722 for regular communications and 703-308-7722 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

QVU

February 1, 2002

TOM THOMAS
SUPERVISORY PATENT EXAMINER

TECHNOLOGY CENTER 2800